DATA SHEET



GaAs MULTI-CHIP MODULE MC-7833

870 MHz CATV 25 dB PUSH-PULL AMPLIFIER

DESCRIPTION

The MC-7833 is a GaAs Multi-chip Module designed for use in CATV applications up to 870 MHz. This unit has low distortion, low noise figure and return loss across the entire frequency band.

Reliability and performance uniformity are assured by our stringent quality and control procedures.

FEATURES

- · Low distortion
- High linear gain

 $G_L = 25.0 \text{ dB MIN. } @f = 870 \text{ MHz}$

Low return loss

ORDERING INFORMATION

Part Number	Order Number	Package	Supplying Form
MC-7833	MC-7833-AZ	7-pin special with heatsink (Pb-Free)	50 pcs MAX./Tray

Remark To order evaluation samples, contact your nearby sales office.

Part number for sample order: MC-7833

ABSOLUTE MAXIMUM RATINGS (TA = +25°C)

Parameter	Symbol	Ratings	Unit
Supply Voltage	V _{DD}	30	٧
Input Voltage Note	Vi	65.0	dBmV
Operating Case Temperature	te Temperature Tc -30 to +100		°C
Storage Temperature	T _{stg}	-40 to +100	°C

Note In case of single tone

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

Not all devices/types available in every country. Please check with local NEC Compound Semiconductor Devices representative for availability and additional information.



RECOMMENDED OPERATING CONDITIONS (Zs = ZL = 75 Ω)

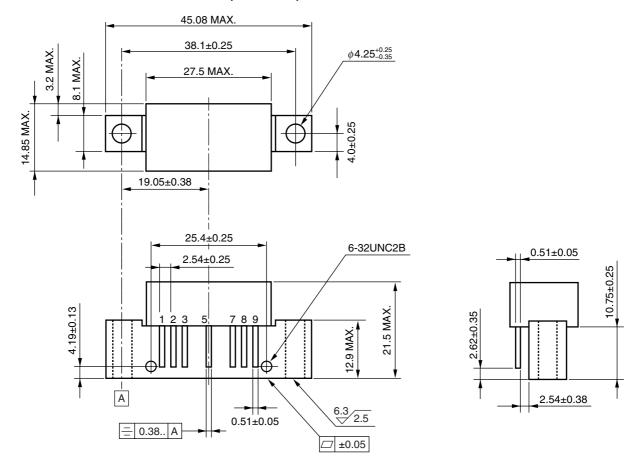
Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Supply Voltage	V _{DD}		23.5	24.0	24.5	٧
Input Voltage	Vi	110 channel, Flat	-	19.0	25.5	dBmV
Operating Case Temperature	Tc		-30	+25	+85	°C

ELECTRICAL CHARACTERISTICS (Tc = 30 \pm 5°C, Vdd = 24 V, Zs = ZL = 75 Ω)

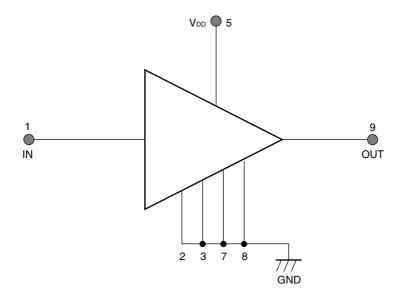
Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Linear Gain	GL	f = 870 MHz	25.0	1	26.0	dB
Gain Slope	GSlope	f = 40 to 870 MHz	1.0	-	1.8	dB
Gain Flatness	GFlatness	f = 40 to 870 MHz, Peak to valley	-	-	0.7	dB
Noise Figure 1	NF ₁	f = 50 MHz	-	-	5.5	dB
Noise Figure 2	NF ₂	f = 870 MHz	ı	ı	6.0	dB
Operating Current	IDD	Pin = None	180	1	240	mA
Composite Triple Beat	СТВ	110 channel,	1	1	-57	dBc
Cross Modulation	XM	Vo = 44 dBmV, Flat	1	1	-50	dBc
Composite 2nd Order Beat	cso		_	-	-57	dBc
Input / Output Return Loss 1	RL ₁	f = 40 to 160 MHz	20	-	-	dB
Input / Output Return Loss 2	RL2	f = 160 to 320 MHz	19	-	_	dB
Input / Output Return Loss 3	RL₃	f = 320 to 640 MHz	17.5	-	_	dB
Input / Output Return Loss 4	RL4	f = 640 to 870 MHz	16	_	-	dB

PACKAGE DIMENSIONS

7-PIN SPECIAL WITH HEATSINK (UNIT: mm)



PIN CONNECTION



NOTES ON CORRECT USE

- (1) The space between PC board and root of the lead should be kept more than 1 mm to prevent undesired stress to the lead and also should be kept less than 4 mm to prevent undesired parasitic inductance. Recommended that space is 2.0 to 3.0 mm typical.
- (2) Recommended torque strength of the screw is 59 to 78 Ncm.
- (3) Form the ground pattern as wide as possible to minimize ground impedance. (to prevent undesired oscillation)
 - All the ground pins must be connected together with wide ground pattern to decrease impedance difference.

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Recommended Condition Symbol
Partial Heating	Peak temperature (pin temperature) : 350°C or below Note Soldering time (per pin of device) : 3 seconds or less	-

Note The point of pin part heating must be kept more than 1.2 mm distance from the root of lead.

When the product(s) listed in this document is subject to any applicable import or export control laws and regulation of the authority having competent jurisdiction, such product(s) shall not be imported or exported without obtaining the import or export license.

- The information in this document is current as of July, 2005. The information is subject to change
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 - "Specific": Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems and medical equipment for life support, etc.

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M8E 00.4-0110

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
 - 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

▶ For further information, please contact

NEC Compound Semiconductor Devices, Ltd. http://www.ncsd.necel.com/

E-mail: salesinfo@ml.ncsd.necel.com (sales and general) techinfo@ml.ncsd.necel.com (technical)

Sales Division TEL: +81-44-435-1573 FAX: +81-44-435-1579

NEC Compound Semiconductor Devices Hong Kong Limited

E-mail: ncsd-hk@elhk.nec.com.hk (sales, technical and general)

 Hong Kong Head Office
 TEL: +852-3107-7303
 FAX: +852-3107-7309

 Taipei Branch Office
 TEL: +886-2-8712-0478
 FAX: +886-2-2545-3859

 Korea Branch Office
 TEL: +82-2-558-2120
 FAX: +82-2-558-5209

NEC Electronics (Europe) GmbH http://www.ee.nec.de/

TEL: +49-211-6503-0 FAX: +49-211-6503-1327

California Eastern Laboratories, Inc. http://www.cel.com/

TEL: +1-408-988-3500 FAX: +1-408-988-0279

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